Contents STF26NM60N-H

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STF26NM60N-H Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	600	V
V _{GS}	Gate-source voltage	± 25	٧
I _D	Drain current (continuous) at T _C = 25 °C	20 ⁽¹⁾	Α
I _D	Drain current (continuous) at T _C = 100 °C	12.6 ⁽¹⁾	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	80 ⁽¹⁾	Α
P _{TOT}	Total dissipation at T _C = 25 °C	30	W
	Derating factor	0.24	
dv/dt (3)	Peak diode recovery voltage slope		V/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T_C =25 °C)	2500	V
T _{stg}	Storage temperature	-55 to 150	°C
Tj	Max. operating junction temperature	150	°C

^{1.} Limited only by maximum temperature allowed

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	4.17	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AS}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj max)	8.5	Α
E _{AS}	Single pulse avalanche energy (starting T_J =25 °C, I_D = I_{AS} , V_{DD} =50 V)	610	mJ

^{2.} Pulse width limited by safe operating area

^{3.} $I_{SD} \leq$ 20 A, di/dt \leq 400 A/ μ s, $V_{DD} \leq$ 80% $V_{(BR)DSS}$

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating V _{DS} = Max rating, @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			0.1	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 10 A		0.135	0.165	Ω

Table 6. Dynamic

					l	
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	1800 115 1.1	-	pF pF pF
C _{oss eq.} (1)	Equivalent output capacitance	$V_{GS} = 0$, $V_{DS} = 0$ to 480 V	1	310	-	pF
$egin{array}{c} Q_{ m g} \ Q_{ m gd} \end{array}$	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 480 \text{ V}, I_{D} = 20 \text{ A},$ $V_{GS} = 10 \text{ V},$ (see Figure 15)	-	60 8.5 30	-	nC nC nC
R_{g}	Gate input resistance	f=1 MHz Gate DC Bias=0 Test signal level = 20 mV open drain	-	2.8	-	Ω

^{1.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} = 300 V, I_D = 10 A R_G = 4.7 Ω V_{GS} = 10 V (see Figure 14)	-	13 25 85 50	-	ns ns ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I _{SD}	Source-drain current		_		20	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)				80	Α
V _{SD} (2)	Forward on voltage	I _{SD} = 20 A, V _{GS} = 0	1		1.5	٧
t _{rr}	Reverse recovery time	$I_{SD} = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		370		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 60 V	-	5.8		μC
I _{RRM}	Reverse recovery current	(see Figure 16)		31.6		Α
t _{rr}	Reverse recovery time	$I_{SD} = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		450		ns
Q_{rr}	Reverse recovery charge	V _{DD} = 60 V, T _j = 150 °C	-	7.5		μC
I _{RRM}	Reverse recovery current	(see Figure 16)		32.5		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STF26NM60N-H

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

10 AM03315v1
10 μs

Sinlge pulse

100

VDS(V)

10

Figure 3. Thermal impedance

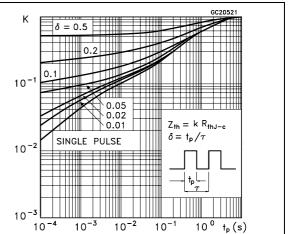


Figure 4. Output characteristics

0.01

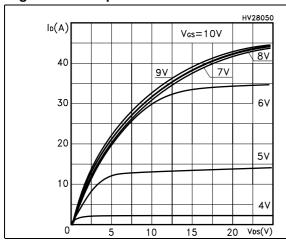


Figure 5. Transfer characteristics

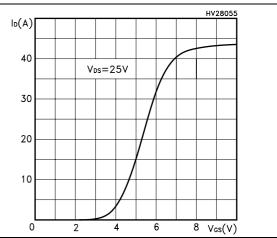


Figure 6. Transconductance

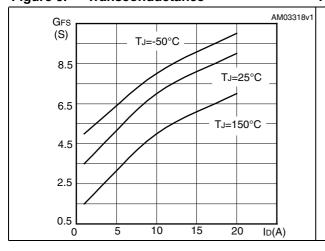
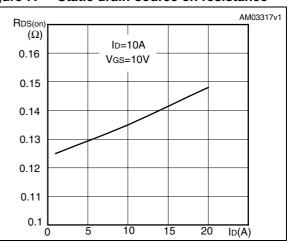


Figure 7. Static drain-source on resistance



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AM03320v1 AM03319v1 Vgs (V) (pF) VDD=480V 12 ID=20A 10000 Vos Vgs 10 Ciss 1000 8 6 100 Coss 4 10 Crss 2 20 30 40 50 60 Qg(nC) 0.1 10 100 V_{DS}(V) 10

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

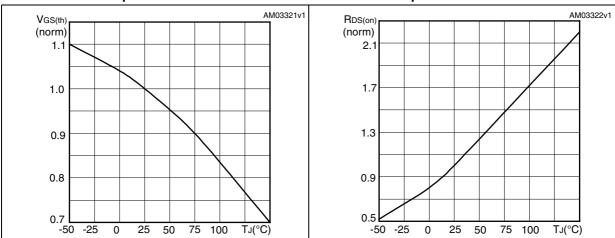
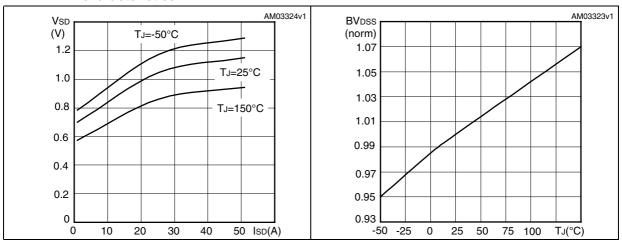


Figure 12. Source-drain diode forward characteristics

Figure 13. Normalized B_{VDSS} vs temperature



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Test circuits STF26NM60N-H

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

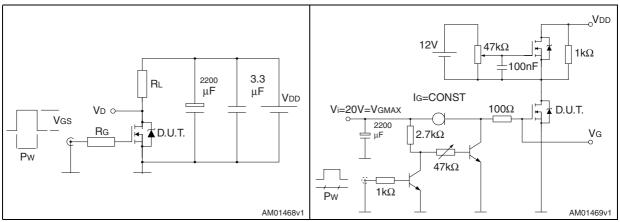


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

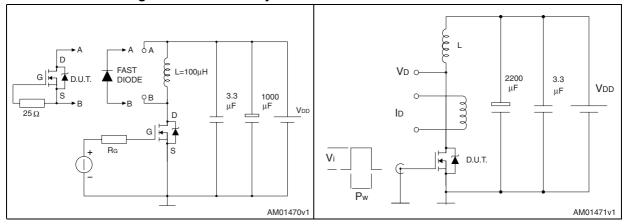
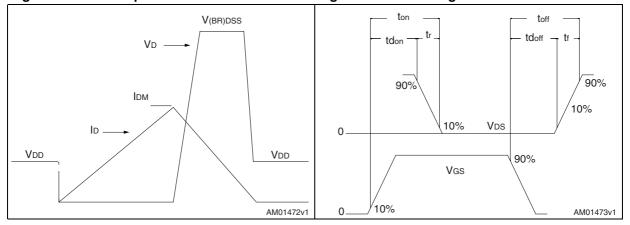


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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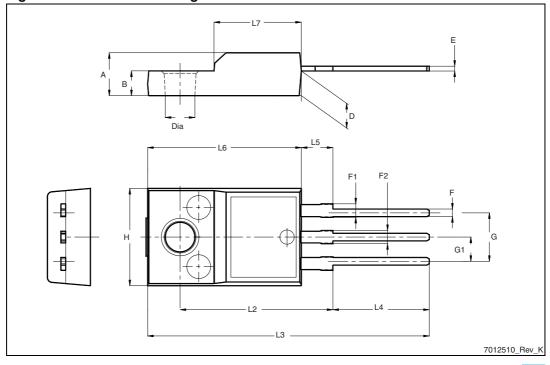
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. TO-220FP mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.4		4.6
В	2.5		2.7
D	2.5		2.75
Е	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.70
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

Figure 20. TO-220FP drawing



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STF26NM60N-H Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
12-Jan-2010	1	First release

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